Electronic Acknowledgement Receipt						
1327866						
10814682						
8308						
Semiconductor device having a doped lattice matching layer and a method of manufacture therefor						
Wen Lin						
47396						
Jimmy L. Heisz/Elizabeth Schumacher						
Jimmy L. Heisz						
LIN 13-38						
21-NOV-2006						
31-MAR-2004						
15:34:04						
Utility						

## Payment information:

Submitted with Payment	yes
Payment was successfully received in RAM	\$790
RAM confirmation Number	128
Deposit Account	082395

## File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
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1	Request for Continued Examination (RCE)	RCE_EFS_Form_8_06.pdf	666691	no	3			
Warnings:								
Information:								
2	Fee Worksheet (PTO-875)	fee-info.pdf	8216	no	2			
Warnings:								
Information:								
		Total Files Size (in bytes)	674907					

This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.

## New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

## National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.